

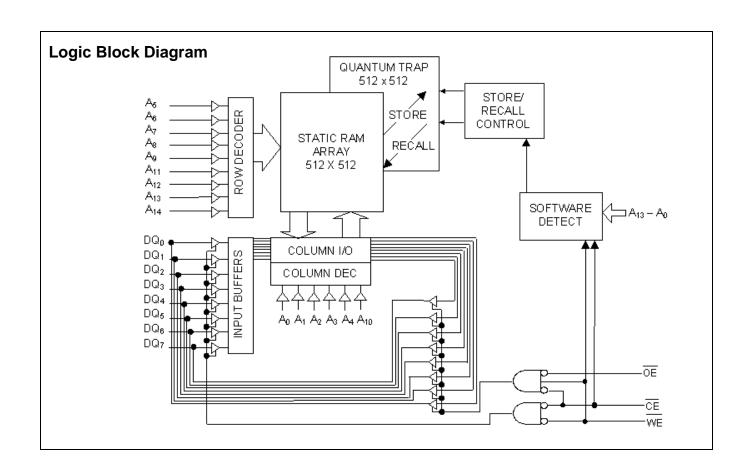
256 Kbit (32K x 8) SoftStore nvSRAM

Features

- 25 ns and 45 ns access times
- Pin compatible with industry standard SRAMs
- Software initiated STORE and RECALL
- Automatic RECALL to SRAM on power up
- Unlimited Read and Write endurance
- Unlimited RECALL cycles
- 1,000,000 STORE cycles
- 100 year data retention
- Single 5V±10% power supply
- Commercial and Industrial Temperatures
- 28-pin (300 mil and 330 mil) SOIC packages
- RoHS compliance

Functional Description

The Cypress STK11C88 is a 256 Kb fast static RAM with a nonvolatile element in each memory cell. The embedded nonvolatile elements incorporate QuantumTrap[™] technology producing the world's most reliable nonvolatile memory. The SRAM provides unlimited read and write cycles, while independent, nonvolatile data resides in the highly reliable QuantumTrap cell. Data transfers under Software control from SRAM to the nonvolatile elements (the STORE operation). On power up, data is automatically restored to the SRAM (the RECALL operation) from the nonvolatile memory. RECALL operations are also available under software control.





Pin Configurations

Figure 1. Pin Diagram - 28-Pin SOIC

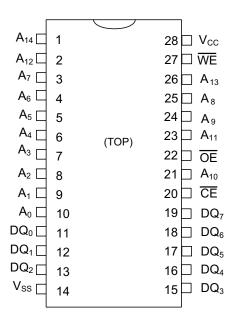


Table 1. Pin Definitions - 28-Pin SOIC

Pin Name	Alt	IO Type	Description
A ₀ -A ₁₄		Input	Address Inputs. Used to select one of the 32,768 bytes of the nvSRAM.
DQ ₀ -DQ ₇		Input or Output	Bidirectional Data IO lines. Used as input or output lines depending on operation.
WE	W	Input	Write Enable Input, Active LOW. When the chip is enabled and WE is LOW, data on the IO pins is written to the specific address location.
CE	Ē	Input	Chip Enable Input, Active LOW. When LOW, selects the chip. When HIGH, deselects the chip.
ŌĒ	G	Input	Output Enable, Active LOW. The active LOW OE input enables the data output buffers during read cycles. Deasserting OE HIGH causes the IO pins to tri-state.
V _{SS}		Ground	Ground for the Device. The device is connected to the ground of the system.
V _{CC}		Power Supply	Power Supply Inputs to the Device.



Device Operation

The STK11C88 is a versatile memory chip that provides several modes of operation. The STK11C88 can operate as a standard 32K x 8 SRAM. A 32K x 8 array of nonvolatile storage elements shadow the SRAM. SRAM data can be copied from nonvolatile memory or nonvolatile data can be recalled to the SRAM.

SRAM Read

The STK11C88 performs a READ cycle whenever $\overline{\text{CE}}$ and $\overline{\text{OE}}$ are LOW, while $\overline{\text{WE}}$ is HIGH. The address specified on pins A_{0-14} determines the 32,768 data bytes accessed. When the READ is initiated by an address transition, the outputs are valid after a delay of t_{AA} (READ cycle 1). If the READ is initiated by $\overline{\text{CE}}$ or $\overline{\text{OE}}$, the outputs are valid at t_{ACE} or at t_{DOE} , whichever is later (READ cycle 2). The data outputs repeatedly respond to address changes within the t_{AA} access time without the need for transitions on any control input pins, and remain valid until another address change or until $\overline{\text{CE}}$ or $\overline{\text{OE}}$ is brought HIGH.

SRAM Write

A WRITE cycle is performed whenever $\overline{\text{CE}}$ and $\overline{\text{WE}}$ are LOW. The address inputs must be stable prior to entering the WRITE cycle and must remain stable until either $\overline{\text{CE}}$ or $\overline{\text{WE}}$ goes HIGH at the end of the cycle. The data on the common IO pins $\overline{\text{DQ}}_{0-7}$ are written into the memory if it has valid t_{SD} , before the end of a $\overline{\text{WE}}$ controlled WRITE or before the end of an $\overline{\text{CE}}$ controlled WRITE. Keep $\overline{\text{OE}}$ HIGH during the entire WRITE cycle to avoid data bus contention on common IO lines. If $\overline{\text{OE}}$ is left LOW, internal circuitry turns off the output buffers t_{HZWE} after $\overline{\text{WE}}$ goes LOW.

Software STORE

Data is transferred from the SRAM to the nonvolatile memory by a software address sequence. The STK11C88 software STORE cycle is initiated by executing sequential CE controlled READ cycles from six specific address locations in exact order. During the STORE cycle, an erase of the previous nonvolatile data is first performed, followed by a program of the nonvolatile elements. When a STORE cycle is initiated, input and output are disabled until the cycle is completed.

Because a sequence of READs from specific addresses is used for STORE initiation, it is important that no other READ or WRITE accesses intervene in the sequence. If they intervene, the sequence is aborted and no STORE or RECALL takes place.

To initiate the software STORE cycle, the following READ sequence is performed:

- 1. Read address 0x0E38, Valid READ
- 2. Read address 0x31C7, Valid READ
- 3. Read address 0x03E0, Valid READ
- 4. Read address 0x3C1F, Valid READ
- 5. Read address 0x303F, Valid READ
- 6. Read address 0x0FC0, Initiate STORE cycle

The software sequence is clocked with $\overline{\text{CE}}$ controlled READs. When the sixth address in the sequence is entered, the STORE cycle commences and the chip is disabled. It is important that READ cycles and not $\overline{\text{WR}}$ ITE cycles are used in the sequence. It is not necessary that $\overline{\text{OE}}$ is LOW for a valid sequence. After the t_{STORE} cycle time is fulfilled, the SRAM is again activated for READ and WRITE operation.

Software RECALL

Data is transferred from the nonvolatile memory to the SRAM by a software address sequence. A software RECALL cycle is initiated with a sequence of READ operations in a manner similar to the software STORE initiation. To initiate the RECALL cycle, the following sequence of CE controlled READ operations is performed:

- 1. Read address 0x0E38, Valid READ
- 2. Read address 0x31C7, Valid READ
- 3. Read address 0x03E0, Valid READ
- 4. Read address 0x3C1F, Valid READ
- 5. Read address 0x303F, Valid READ
- 6. Read address 0x0C63, Initiate RECALL cycle

Internally, RECALL is a two step procedure. First, the SRAM data is cleared, and then the nonvolatile information is transferred into the SRAM cells. After the t_{RECALL} cycle time, the SRAM is once again ready for READ and WRITE operations. The RECALL operation does not alter the data in the nonvolatile elements. The nonvolatile data can be recalled an unlimited number of times.

Hardware RECALL (Power Up)

During power up or after any low power condition (V $_{CC}$ <V $_{RESET}$), an internal RECALL request is latched. When V $_{CC}$ once again exceeds the sense voltage of V $_{SWITCH}$, a RECALL cycle is automatically initiated and takes t $_{HRECALL}$ to complete.

If the STK11C88 is in a WRITE state at the end of power up RECALL, the SRAM data is corrupted. To help avoid this situation, a 10 Kohm resistor is connected either between WE and system V_{CC} or between CE and system V_{CC} .



Hardware Protect

The STK11C88 offers hardware protection against inadvertent STORE operation and SRAM WRITEs during low voltage conditions. When $V_{\rm CC} < V_{\rm SWITCH}$, all externally initiated STORE operations and SRAM WRITEs are inhibited.

Noise Considerations

The STK11C88 is a high speed memory. It must have a high frequency bypass capacitor of approximately 0.1 μF connected between V $_{CC}$ and V $_{SS}$, using leads and traces that are as short as possible. As with all high speed CMOS ICs, careful routing of power, ground, and signals help prevent noise problems.

Low Average Active Power

CMOS technology provides the STK11C88 the benefit of drawing significantly less current when it is cycled at times longer than 50 ns. Figure 2 and Figure 3 show the relationship between I_{CC} and READ or WRITE cycle time. Worst case current consumption is shown for both CMOS and TTL input levels (commercial temperature range, VCC = 5.5V, 100 percent duty cycle on chip enable). Only standby current is drawn when the chip is disabled. The overall average current drawn by the STK11C88 depends on the following items:

- 1. The duty cycle of chip enable
- 2. The overall cycle rate for accesses
- 3. The ratio of READs to WRITEs
- 4. CMOS versus TTL input levels
- 5. The operating temperature
- 6. The V_{CC} level
- 7. IO loading

Figure 2. Icc (max) Reads

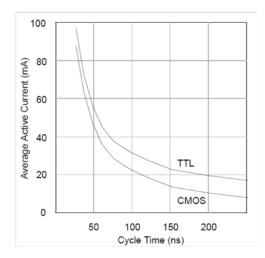
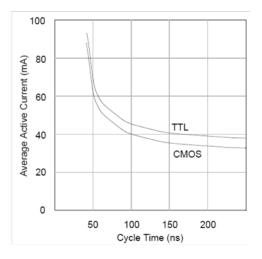


Figure 3. Icc (max) Writes



Best Practices

nvSRAM products have been used effectively for over 15 years. While ease-of-use is one of the product's main system values, the experience gained working with hundreds of applications has resulted in the following suggestions as best practices:

- The nonvolatile cells in a nvSRAM are programmed on the test floor during final test and quality assurance. Incoming inspection routines at customer or contract manufacturer's sites, sometimes, reprogram these values. Final NV patterns are typically repeating patterns of AA, 55, 00, FF, A5, or 5A. The end product's firmware should not assume that a NV array is in a set programmed state. Routines that check memory content values to determine first time system configuration and cold or warm boot status, should always program a unique NV pattern (for example, a complex 4-byte pattern of 46 E6 49 53 hex or more random bytes) as part of the final system manufacturing test to ensure these system routines work consistently.
- Power up boot firmware routines should rewrite the nvSRAM into the desired state. While the nvSRAM is shipped in a preset state, best practice is to again rewrite the nvSRAM into the desired state as a safeguard against events that might flip the bit inadvertently (program bugs or incoming inspection routines).



Table 2. Software STORE/RECALL Mode Selection

CE	WE	A ₁₃ – A ₀	Mode	10	Notes
L	Н	0x0E38 0x31C7 0x03E0 0x3C1F 0x303F 0x0FC0	Read SRAM Read SRAM Read SRAM Read SRAM Read SRAM Nonvolatile STORE	Output Data	[1, 2]
L	Н	0x0E38 0x31C7 0x03E0 0x3C1F 0x303F 0x0C63	Read SRAM Read SRAM Read SRAM Read SRAM Read SRAM Nonvolatile RECALL	Output Data	[1, 2]

Notes

1. The six consecutive addresses must be in the order listed. WE must be high during all six consecutive CE controlled cycles to enable a nonvolatile cycle.

2. While there are 15 addresses on the STK11C88, only the lower 14 are used to control software modes.



Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. These user guidelines are not tested.

Storage Temperature	65°C to +150°C
Temperature under bias	55°C to +125°C
Supply Voltage on V _{CC} Relative to GND	–0.5V to 7.0V
Voltage on Input Relative to Vss	$-0.6V$ to $V_{CC} + 0.5V$

Voltage on DQ ₀₋₇	0.5V to Vcc + 0.5V
Power Dissipation	1.0W
DC Output Current (1 output at a time	ne, 1s duration) 15 mA

Operating Range

Range	Ambient Temperature	V _{CC}		
Commercial	0°C to +70°C	4.5V to 5.5V		
Industrial	-40°C to +85°C	4.5V to 5.5V		

DC Electrical Characteristics

Over the operating range ($V_{CC} = 4.5V$ to 5.5V)

Parameter	Description	Test Conditions		Min	Max	Unit
I _{CC1}	Average V _{CC} Current	$t_{RC} = 45 \text{ ns}$	Commercial		97 70	mA mA
		Dependent on output loading and cycle rate. Values obtained without output loads. $I_{OUT} = 0$ mA.	Industrial		100 70	mA mA
I _{CC2}	Average V _{CC} Current during STORE	All Inputs Do Not Care, V _{CC} = Max Average current for duration t _{STORE}			3	mA
Іссз	Average V _{CC} Current at t _{RC} = 200 ns, 5V, 25°C Typical	$\overline{\text{WE}} \ge (\text{V}_{\text{CC}} - 0.2\text{V})$. All other inputs cycling. Dependent on output loading and cycle rate. Valuation without output loads.	alues obtained		10	mA
I _{SB1} ^[3]	(Standby, Cycling	t_{RC} =25ns, $\overline{CE} \ge V_{IH}$ t_{RC} =45ns, $\overline{CE} \ge V_{IH}$	Commercial		30 22	mA
	TTL Input Levels)		Industrial		31 23	mA
I _{SB2} ^[3]	V _{CC} Standby Current (Standby, Stable CMOS Input Levels)	$\overline{CE} \ge (V_{CC} - 0.2V)$. All others $V_{IN} \le 0.2V$ or $\ge (V_{CC} - 0.2V)$.	V _{CC} – 0.2V).		750	μА
I _{IX}	Input Leakage Current	$V_{CC} = Max, V_{SS} \le V_{IN} \le V_{CC}$		-1	+1	μА
I _{OZ}	Off State Output Leakage Current	$V_{CC} = Max, V_{SS} \le V_{IN} \le V_{CC}, \overline{CE} \text{ or } \overline{OE} \ge V_{IH} C$	or WE ≤ V _{IL}	-5	+5	μА
V _{IH}	Input HIGH Voltage			2.2	V _{CC} + 0.5	٧
V _{IL}	Input LOW Voltage			V _{SS} - 0.5	0.8	V
V _{OH}	Output HIGH Voltage	I _{OUT} = -4 mA		2.4		V
V _{OL}	Output LOW Voltage	I _{OUT} = 8 mA			0.4	V

Data Retention and Endurance

Parameter	Description	Min	Unit
DATA _R	Data Retention	100	Years
NV_C	Nonvolatile STORE Operations	1,000	K

Note_
3. CE ≥ V_{IH} will not produce standby current levels until any nonvolatile cycle in progress has timed out.



Capacitance

In the following table, the capacitance parameters are listed. [4]

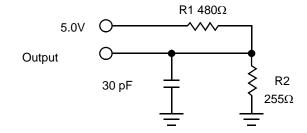
Parameter	Description	Test Conditions	Max	Unit
C _{IN}	Input Capacitance	$T_A = 25$ °C, $f = 1$ MHz,	5	pF
C _{OUT}	Output Capacitance	$V_{CC} = 0$ to 3.0 V	7	pF

Thermal Resistance

In the following table, the thermal resistance parameters are listed. [4]

Parameter	Description	Test Conditions	28-SOIC (300 mil)	28-SOIC (330 mil)	Unit
Θ_{JA}	Thermal Resistance (Junction to Ambient)	Test conditions follow standard test methods and procedures for measuring thermal impedance,	TBD	TBD	°C/W
$\Theta_{\sf JC}$	Thermal Resistance (Junction to Case)	per EIA / JESD51.	TBD	TBD	°C/W

Figure 4. AC Test Loads



AC Test Conditions

Input Pulse Levels	0 V to 3 V
Input Rise and Fall Times (10% - 90%)	<u><</u> 5 ns
Input and Output Timing Reference Levels	1.5 V

^{4.} These parameters are guaranteed by design and are not tested.



AC Switching Characteristics

SRAM Read Cycle

Parameter			25	25 ns		45 ns	
Cypress Parameter	Alt	Description	Min	Max	Min	Max	Unit
t _{ACE}	t _{ELQV}	Chip Enable Access Time		25		45	ns
t _{RC} [5]	t _{AVAV} , t _{ELEH}	Read Cycle Time	25		45		ns
t _{AA} ^[6]	t _{AVQV}	Address Access Time		25		45	ns
t _{DOE}	t _{GLQV}	Output Enable to Data Valid		10		20	ns
t _{OHA} ^[6]	t _{AXQX}	Output Hold After Address Change	5		5		ns
t _{LZCE} [7]	t _{ELQX}	Chip Enable to Output Active	5		5		ns
t _{HZCE} [7]	t _{EHQZ}	Chip Disable to Output Inactive		10		15	ns
t _{LZOE} [7]	t _{GLQX}	Output Enable to Output Active	0		0		ns
t _{HZOE} [7]	t _{GHQZ}	Output Disable to Output Inactive		10		15	ns
t _{PU} ^[4]	t _{ELICCH}	Chip Enable to Power Active	0		0		ns
t _{PD} [4]	t _{EHICCL}	Chip Disable to Power Standby		25		45	ns

Switching Waveforms

Figure 5. SRAM Read Cycle 1: Address Controlled [5, 6]

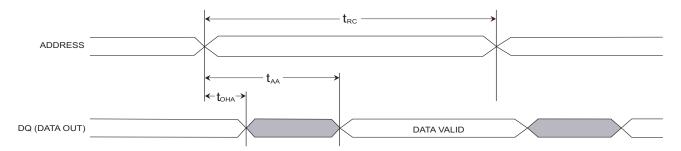
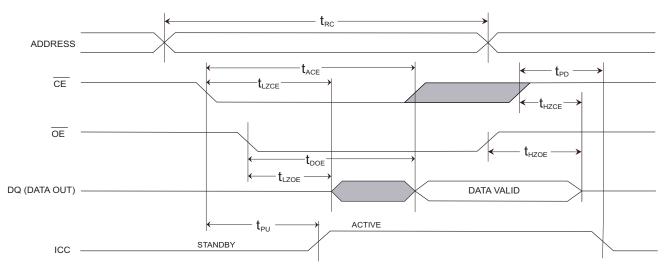


Figure 6. SRAM Read Cycle 2: $\overline{\text{CE}}$ and $\overline{\text{OE}}$ Controlled [5]





SRAM Write Cycle

Parameter			25	25 ns		45 ns	
Cypress Parameter	Alt	Description	Min	Max	Min	Max	Unit
t _{WC}	t _{AVAV}	Write Cycle Time	25		45		ns
t _{PWE}	t _{WLWH} , t _{WLEH}	Write Pulse Width	20		30		ns
t _{SCE}	t _{ELWH} , t _{ELEH}	Chip Enable To End of Write	20		30		ns
t _{SD}	t _{DVWH} , t _{DVEH}	Data Setup to End of Write	10		15		ns
t _{HD}	t _{WHDX} , t _{EHDX}	Data Hold After End of Write	0		0		ns
t _{AW}	t _{AVWH} , t _{AVEH}	Address Setup to End of Write	20		30		ns
t _{SA}	t _{AVWL} , t _{AVEL}	Address Setup to Start of Write	0		0		ns
t _{HA}	t _{WHAX} , t _{EHAX}	Address Hold After End of Write	0		0		ns
t _{HZWE} [7,8]	t_{WLQZ}	Write Enable to Output Disable		10		15	ns
t _{LZWE} [7]	t_{WHQX}	Output Active After End of Write	5		5		ns

Switching Waveforms

Figure 7. SRAM Write Cycle 1: WE Controlled [9]

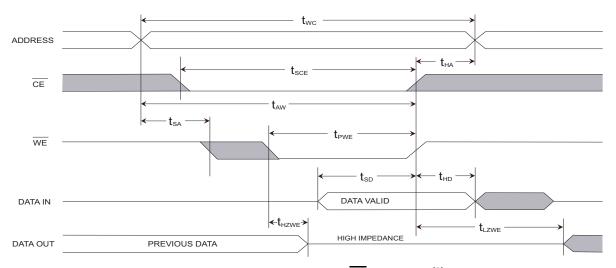
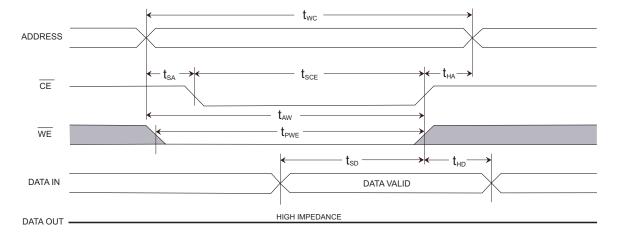


Figure 8. SRAM Write Cycle 2: $\overline{\text{CE}}$ Controlled [9]



- 9. $\overline{\text{CE}}$ or $\overline{\text{WE}}$ must be greater than V_{IH} during address transitions.

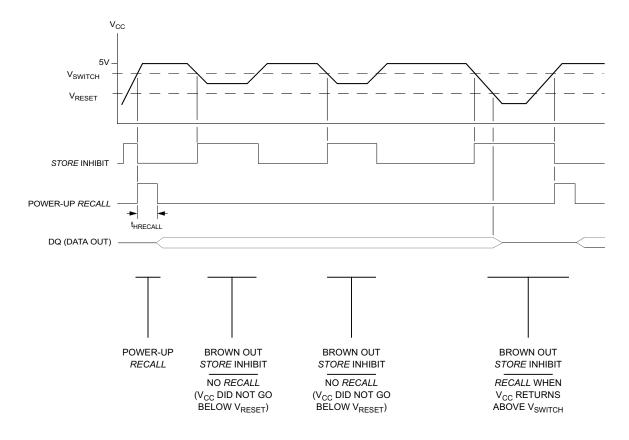


STORE INHIBIT or Power Up RECALL

Parameter	Alt	Description	STK11C88		Unit	
Farailletei		Description	Min			
t _{HRECALL} [10]	t _{RESTORE}	Power up RECALL Duration		550	μS	
t _{STORE} [6]	t _{HLHZ}	STORE Cycle Duration		10	ms	
V _{RESET}		Low Voltage Reset Level		3.6	V	
V _{SWITCH}		Low Voltage Trigger Level	4.0	4.5	V	

Switching Waveforms

Figure 9. STORE INHIBIT/Power Up RECALL



Notes

^{10.} t_{HRECALL} starts from the time V_{CC} rises above V_{SWITCH} .



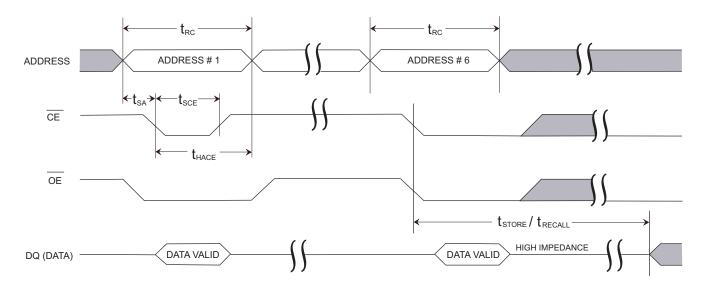
Software Controlled STORE/RECALL Cycle

The software controlled STORE/RECALL cycle follows. [11, 12]

Parameter	Alt	Description	25 ns		45 ns		Unit
Parameter		Description	Min	Max	Min	Max	Onit
t _{RC}	t _{AVAV}	STORE/RECALL Initiation Cycle Time	25		45		ns
t _{SA} ^[11]	t _{AVEL}	Address Setup Time	0		0		ns
t _{CW} ^[11]	t _{ELEH}	Clock Pulse Width	20		30		ns
t _{HACE} ^[11]	t _{ELAX}	Address Hold Time	20		20		ns
t _{RECALL} [11]		RECALL Duration		20		20	μS

Switching Waveforms

Figure 10. CE Controlled Software STORE/RECALL Cycle [12]



Notes

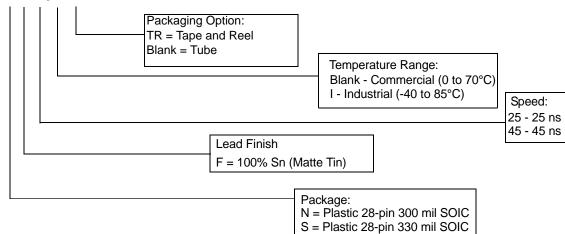
^{11.} The software sequence is clocked on the falling edge of $\overline{\text{CE}}$ without involving $\overline{\text{OE}}$ (double clocking abort the sequence).

12. The six consecutive addresses must be read in the order listed in the Mode Selection table. $\overline{\text{WE}}$ must be HIGH during all six consecutive cycles.



Part Numbering Nomenclature

STK11C88 - N F 25 I TR



Ordering Information

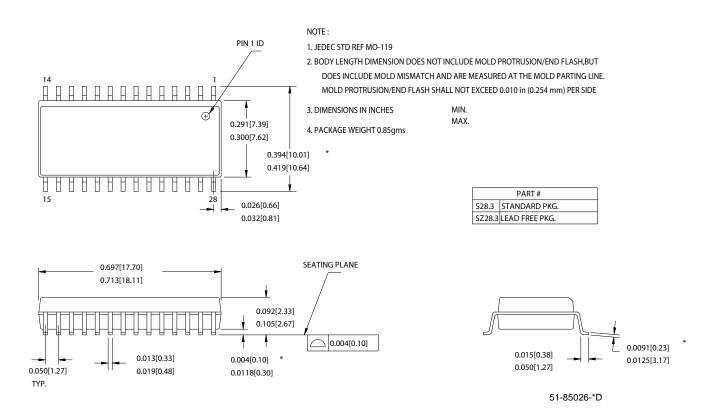
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
25	STK11C88-NF25TR	51-85026	28-Pin SOIC (300 mil)	Commercial
	STK11C88-NF25	51-85026	28-Pin SOIC (300 mil)	
	STK11C88-SF25TR	51-85058	28-Pin SOIC (330 mil)	
	STK11C88-SF25	51-85058	28-Pin SOIC (330 mil)	
	STK11C88-NF25ITR	51-85026	28-Pin SOIC (300 mil)	Industrial
	STK11C88-NF25I	51-85026	28-Pin SOIC (300 mil)	
	STK11C88-SF25ITR	51-85058	28-Pin SOIC (330 mil)	
	STK11C88-SF25I	51-85058	28-Pin SOIC (330 mil)	
45	STK11C88-NF45TR	51-85026	28-Pin SOIC (300 mil)	Commercial
	STK11C88-NF45	51-85026	28-Pin SOIC (300 mil)	
	STK11C88-SF45TR	51-85058	28-Pin SOIC (330 mil)	
	STK11C88-SF45	51-85058	28-Pin SOIC (330 mil)	
	STK11C88-NF45ITR	51-85026	28-Pin SOIC (300 mil)	Industrial
	STK11C88-NF45I	51-85026	28-Pin SOIC (300 mil)	
	STK11C88-SF45ITR	51-85058	28-Pin SOIC (330 mil)	
	STK11C88-SF45I	51-85058	28-Pin SOIC (330 mil)	

All parts are Pb-free. The above table contains Final information. Contact your local Cypress sales representative for availability of these parts



Package Diagrams

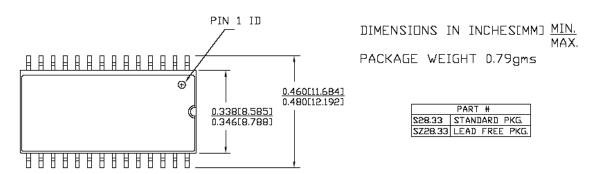
Figure 11. 28-Pin (300 mil) SOIC (51-85026)

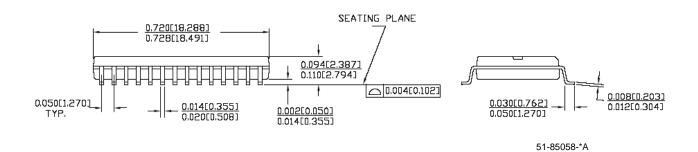




Package Diagrams (continued)

Figure 12. 28-Pin (330 mil) SOIC (51-85058)







Document History Page

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Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change	
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Page 15 of 15

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